

	Type	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L1	58354	(light adj emi\$4) and (copper saem substrate)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/08/21 13:56
2	BRS	L2	2592	(light adj emi\$4) and (copper same substrate)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/08/21 13:56
3	BRS	L3	75	(light adj emi\$4 adj device) and (copper same substrate)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/08/21 14:21
4	BRS	L4	152	(light adj emi\$4 adj device) and (copper same (Al2O3 or AlN or Al or aluminum or SiN))	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/08/21 15:08

	Comments	Error Definition	Errors
1			
2			
3			
4			

	Type	L #	Hits	Search Text	DBs	Time Stamp
5	BRS	L5	18	(light adj emi\$4 adj device) and (copper same (Al2O3 or AlN or Al or aluminum or SiN) same heat)	US-PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TDB	2005/08/21 14:24
6	BRS	L6	508	257/99,98,95,79,81.ccls. and (copper) and (aluminum or (aluminum adj oxide) or (Aluminum adj nitride) or (silicon adj nitride))	US-PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TDB	2005/08/21 15:13
7	BRS	L7	279	257/99,98,95,79,81.ccls. and ((copper) with (aluminum or (aluminum adj oxide) or (Aluminum adj nitride) or (silicon adj nitride)))	US-PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TDB	2005/08/21 15:13
8	BRS	L8	43	257/99,98,95,79,81.ccls. and ((copper) with (aluminum or (aluminum adj oxide) or (Aluminum adj nitride) or (silicon adj nitride)) with (substrate))	US-PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TDB	2005/08/21 16:11

	Comments	Error Definition	Errors
5			
6			
7			
8			

	Type	L #	Hits	Search Text	DBs	Time Stamp
9	BRS	L9	65	"257"/\$.ccls. and ((copper) near (adhesion adj layer))	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/08/21 16:39
10	IS&R	L10	2	("20020175339").PN.	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/08/21 16:39

	Comments	Error Definition	Errors
9			
10			

	Type	Hits	Search Text
1	BRS	2398	(LED) and (copper with substrate)
2	BRS	129	(LED) and (copper with substrate) and (second adj substrate)
3	IS&R	1780	(257/99).CCLS.
4	BRS	11	257/99.ccls. and (copper) and (second adj substrate)
5	BRS	12	257/79-103.ccls. and (copper with ceramic with substrate)
6	BRS	11	257/79-103.ccls. and (LED with (second adj substrate))
7	BRS	5	"257"/\$.ccls. and ((light adj emitting adj diode) with (second adj substrate) with (first adj substrate))
8	BRS	34	((light adj emitting adj diode) with (second adj substrate))
9	BRS	241	257/99.ccls. and (copper)
10	BRS	32	257/79-103.ccls. and (copper) and (second adj substrate)
11	IS&R	2	("4012833").PN.
12	IS&R	2617	(257/690-690,730-733).CCLS.

	DBs	Time Stamp	Comments	Error Definition
1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/08/21 13:55		
2	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/08/10 14:23		
3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	2004/08/10 14:38		
4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/08/11 09:53		
5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/08/10 17:16		
6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/08/10 17:45		
7	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/08/10 17:52		
8	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/08/10 17:52		
9	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/08/11 09:54		
10	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/08/11 10:47		
11	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	2004/08/11 10:48		
12	USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 14:21		

	Errors	Ref #
1		S2
2		S3
3		S4
4		S5
5		S6
6		S7
7		S8
8		S9
9		S10
10		S11
11		S12
12		S1